



Nanomaterials in Medical Engineering

Guest Editor:

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submissions:

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Message from the Guest Editor

This Special Issue intends to gather original scientific peer-reviewed articles and review articles featuring important and recent developments or achievements in nanomaterial research, with an emphasis on medical applications and potential applications. Authors who are well-known experts in their domain are invited to submit their contribution at any time until the end of June 2021. Papers can cover either the experimental or theoretical aspect, or both aspects, of nanomaterials (organic, inorganic, or hybrid) in medical applications, including diagnosis, drug delivery, tissue engineering, regenerative medicine, prostheses, and implants.





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Message from the Editor-in-Chief

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